# Chip Terminations Style CT

## **General Specifications**

• Nominal Impedence: 50  $\Omega$ 

 Resistive Tolerance: ±5% Standard (2% Available).

• Operating Temp Range: -55 to +150°C

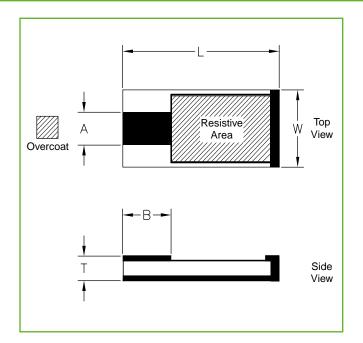
Temperature Coefficient: ±150 ppm/°C

• Resistive Elements: Proprietary film.

Substrate Material: Aluminum Nitride.

• Terminals: Silver

Reliability: MIL-PRF-55342

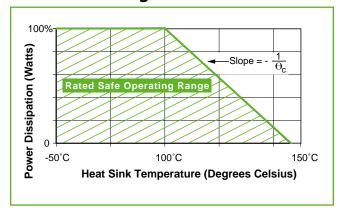


ATC Part Number	W	L	Т	Α	В	Frequency	VSWR	Power Max*
	±.010	±.010	±.005	±.010	±.005	Range (GHz)	(Max.)	(Watts)
CT11005T0050J	.050	.100	.025	.045	.030	DC to 4.0	1.20:1	5W
CT11206T0050J	.060	.120	.025	.055	.025	DC to 4.0	1.25:1	15W
CT12010T0050J	.100	.200	.040	.050	.044	DC to 4.0	1.25:1	30W
CT12525T0050J	.250	.250	.040	.050	.030	DC to 2.5	1.15:1	60W
CT12335T0050J	.350	.230	.040	.100	.040	DC to 4.0	1.15:1	50W
CT13725T0050J	.250	.375	.040	.030	.030	DC to 1.1	1.20:1	150W
CT13737T0050J	.375	.375	.040	.130	.030	DC to 1.0	1.30:1	225W

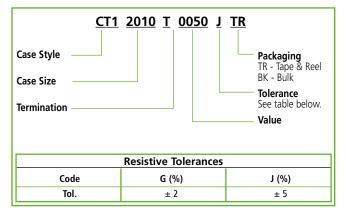
<sup>\*</sup> Test Condition: Chip soldered to a large copper carrier whose surface is at 100° C; maximum rated power applied.

Specification: The resistance of the film shall change no more than 0.5% during and after a 1000-hr. Burn-in per Mil-PRF-55342

# **Power Derating**



#### **ATC Part Number Code**



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COMPONENT AND CUSTOM INTEGRATED PACKAGING SOLUTIONS FOR RF, MICROWAVE AND TELECOMMUNICATIONS